

Data Sheet August 11, 2009 FN4824.2

Radiation Hardened 8 Channel CMOS Analog Multiplexer with Overvoltage Protection

The HS-508BRH is a dielectrically isolated, radiation hardened, CMOS analog multiplexer incorporating an important feature; it withstands analog input voltages much greater than the supplies. This is essential in any system where the analog inputs originate outside the equipment. They can withstand a continuous input up to 10V greater than either supply, which eliminates the possibility of damage when supplies are off, but input signals are present. Equally important, it can withstand brief input transient spikes of several hundred volts; which otherwise would require complex external protection networks. Necessarily, ON resistance is somewhat higher than similar unprotected devices, but very low leakage current combine to produce low errors. Reference Application Notes 520 and 521 for further information on the HS-508BRH multiplexer in general.

The HS-508BRH has been specifically designed to meet exposure to radiation environments. Operation from -55°C to +125°C is guaranteed.

Features

- Electrically Screened to SMD # 5962-96742
- QML Qualified per MIL-PRF-38535 Requirements
- Radiation Environment
 - Gamma Dose (γ) 3 x 10⁵ Rad (Si)
 - Dielectrically Isolated Device Islands
 - SEP >100 Mev-mg/cm²
- Analog/Digital Overvoltage Protection
- ESD Rated to 3kV
- Fail Safe with Power Loss (No Latchup)
- · Break-Before-Make Switching
- (Typ) DTL/TTL and CMOS Compatible Threshold
- Analog Signal Range.....±15V
- Fast Access Time
- Supply Current at 1MHz Address Toggle 4mA (Typ)
- Pb-Free (RoHS Compliant)

Specifications for Rad Hard QML devices are controlled by the Defense Supply Center in Columbus (DSCC). The SMD numbers listed here must be used when ordering.

Detailed Electrical Specifications for these devices are contained in SMD 5962-96742. A "hot-link" is provided on our homepage for downloading.

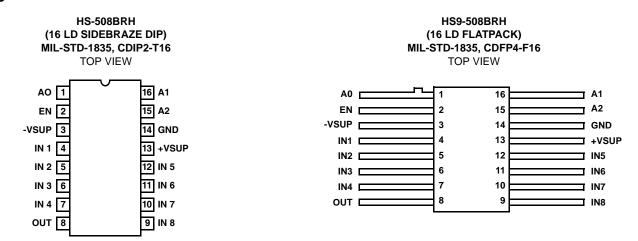
www.intersil.com/spacedefense/newsafclasst.asp

Ordering Information

ORDERING NUMBER (Note)	INTERNAL MKT. NUMBER	PART MARKING	TEMP. RANGE (°C)	PACKAGE (Pb-Free)	PKG. DWG.
5962F9674202QEC	HS1-508BRH-8	Q 5962F96 74202QEC	-55 to +125	16 Ld SBDIP	D16.3
5962F9674202QXC	HS9-508BRH-8	Q 5962F96 74202QXC	-55 to +125	16 Ld FLATPACK	K16.A
5962F9674202VEC	HS1-508BRH-Q	Q 5962F96 74202VEC	-55 to +125	16 Ld SBDIP	D16.3
5962F9674202VXC	HS9-508BRH-Q	Q 5962F96 74202VXC	-55 to +125	16 Ld FLATPACK	K16.A
HS1-508BRH/PROTO	HS1-508BRH/PROTO	HS1- 508BRH /PROTO	-55 to +125	16 Ld SBDIP	D16.3
HS9-508BRH/PROTO	HS9-508BRH/PROTO	HS9- 508BRH /PROTO	-55 to +125	16 Ld FLATPACK	K16.A

NOTE: These Intersil Pb-free Hermetic packaged products employ 100% Au plate - e4 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations.

Pinouts



Functional Diagram

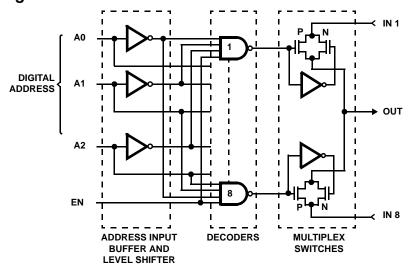


TABLE 1. TRUTH TABLE

A2	A1	A0	EN	"ON" CHANNEL
Х	Х	Х	L	NONE
L	L	L	Н	1
L	L	Н	Н	2
L	Н	L	Н	3
L	Н	Н	Н	4
Н	L	L	Н	5
Н	L	Н	Н	6
Н	Н	L	Н	7
Н	Н	Н	Н	8

Die Characteristics

DIE DIMENSIONS

120 mils x 93 mils x 19 mils

INTERFACE MATERIALS

Glassivation

Type: Phosphorus Silicon Glass (PSG)

Thickness: 8kÅ ±1kÅ

Top Metallization

Type: AlSiCu

Thickness: 16kÅ ±2kÅ

Substrate

Rad Hard Silicon Gate Dielectric Isolation

Backside Finish

Silicon

ASSEMBLY RELATED INFORMATION

Substrate Potential

Unbiased (DI)

ADDITIONAL INFORMATION

Worst Case Current Density

6.68e04 A/cm²

Transistor Count

506

Metallization Mask Layout

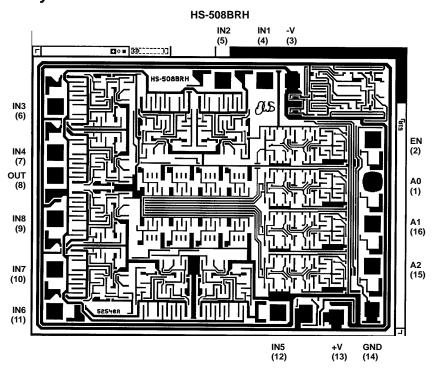


TABLE 2. HS-508BRH PAD COORDINATES

		RELATIVE TO PIN 1		
PIN NUMBER	PAD NAME	X COORDINATES	Y COORDINATES	
1	A0	0	0	
2	EN	-342	0	
3	V-	-818	-653	
4	IN1	-818	-879	
5	IN2	-818	-1221	
6	IN3	-598	-2579	
7	IN4	-224	-2579	
8	OUT	-38	-2579	

HS-508BRH

TABLE 2. HS-508BRH PAD COORDINATES (Continued)

		RELATIVE TO PIN 1			
PIN NUMBER	PAD NAME	X COORDINATES	Y COORDINATES		
9	IN8	314	-2579		
10	IN7	724	-2579		
11	IN6	1066	-2579		
12	-IN5	1066	-761		
13	V+	1100	-287		
14	GND	1038	0		
15	A2	684	0		
16	A1	342	0		

NOTE: Dimensions in microns

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